

## **MOSFET**

# OptiMOS<sup>™</sup> 5 Power-Transistor, 25 V

## **Features**

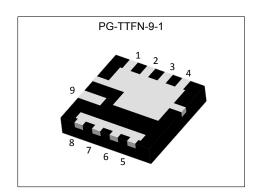
- Very low on-resistance R<sub>DS(on)</sub>
  100% avalanche tested
- Superior thermal resistance
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

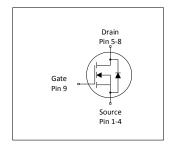
## **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

Parameter	Value	Unit
<b>V</b> <sub>DS</sub>	25	V
R <sub>DS(on),max</sub>	0.65	mΩ
I <sub>D</sub>	298	A
Qoss	41	nC
Q <sub>G</sub> (0V4.5V)	29	nC











Type / Ordering Code	Package	Marking	Related Links
IQE006NE2LM5CG	PG-TTFN-9-1	006E2C5	-



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1 Maximum ratings at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Course to all	Values				Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	298 188 41	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =60 °C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1192	Α	<i>T</i> <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	140	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-16	-	16	V	-
Power dissipation	P <sub>tot</sub>	-	-	89 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>THJA</sub> =60 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area	R <sub>thJA</sub>	-	-	60	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	25	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.2	1.6	2	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 250 \ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =20 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =16 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.50 0.65	0.65 0.80	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =20 A
Gate resistance <sup>1)</sup>	R <sub>G</sub>	-	0.7	1.2	Ω	-
Transconductance	<b>g</b> fs	-	220	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 **Dynamic characteristics** 

Parameter	O. mala al	Values				N
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	4100	5453	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1700	2261	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	130	195	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =12 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	5.3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	2.6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	27.0	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	5.3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Dovomotov	Cumbal	Values			11	Nata / Taat Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	9.2	-	nC	V <sub>DD</sub> =12 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	5.8	-	nC	$V_{DD}$ =12 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	5.6	8.4	nC	V <sub>DD</sub> =12 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	9.0	-	nC	$V_{DD}$ =12 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	28.5	37.9	nC	$V_{DD}$ =12 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.2	-	V	$V_{DD}$ =12 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	61.7	82.1	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	60.4	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge	Qoss	-	41.3	-	nC	V <sub>DD</sub> =12 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

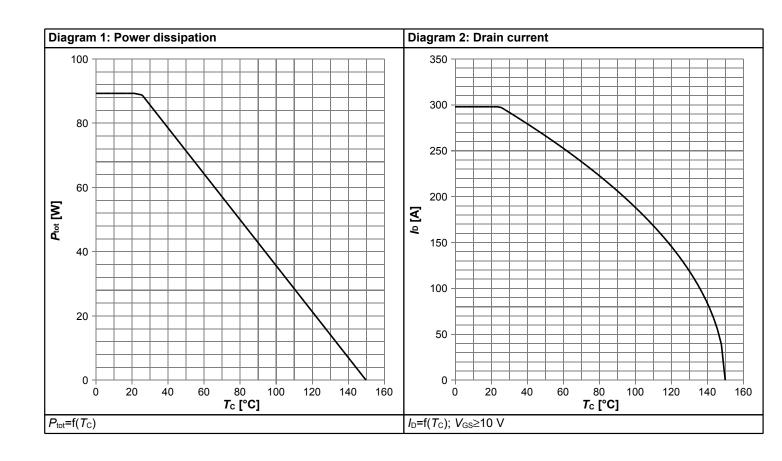


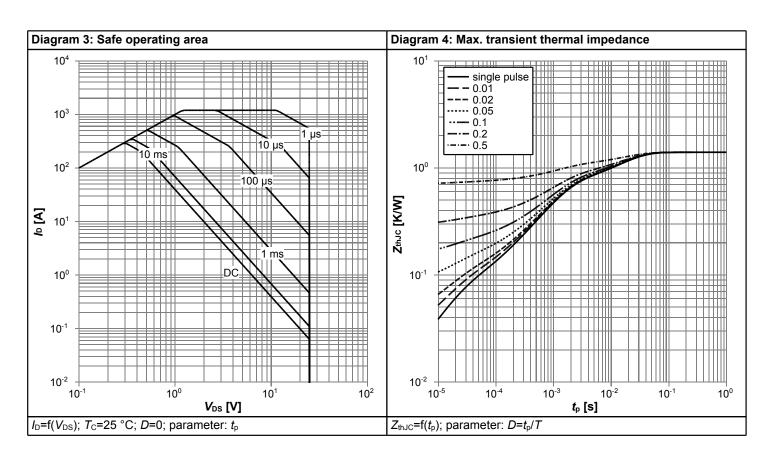
## Table 7 Reverse diode

Doromotor	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I <sub>S</sub>	-	-	83	Α	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	1192	Α	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.75	1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C
Reverse recovery charge	Qrr	-	25	-	nC	V <sub>R</sub> =12 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

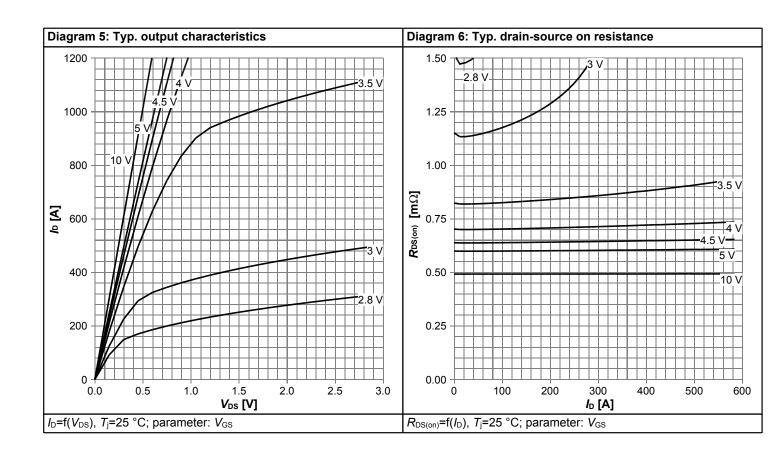


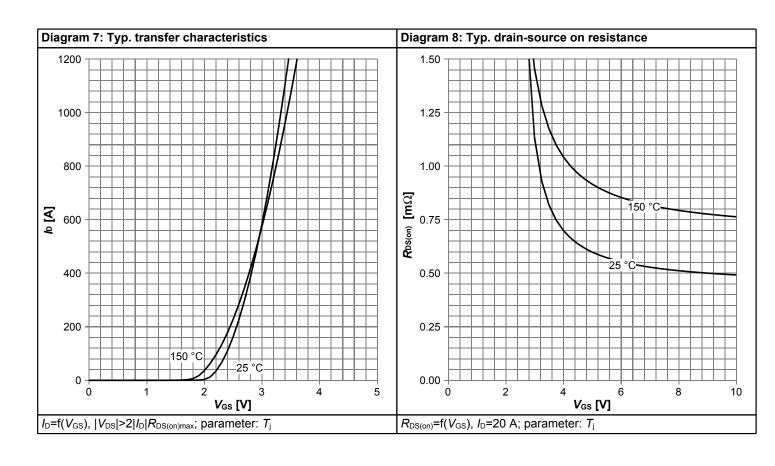
## 4 Electrical characteristics diagrams



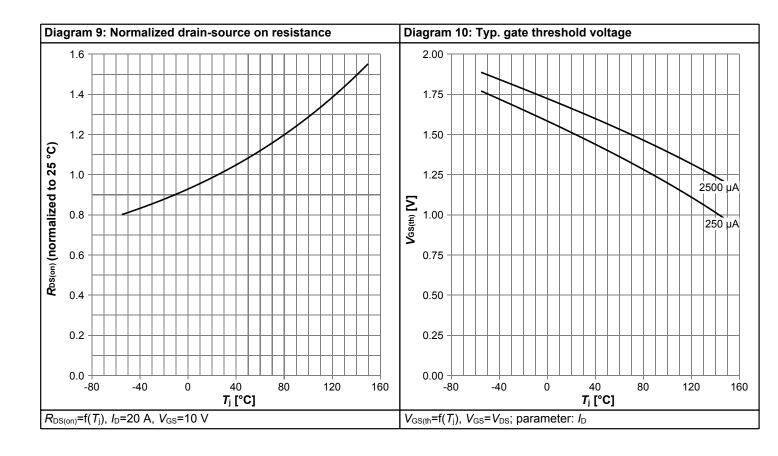


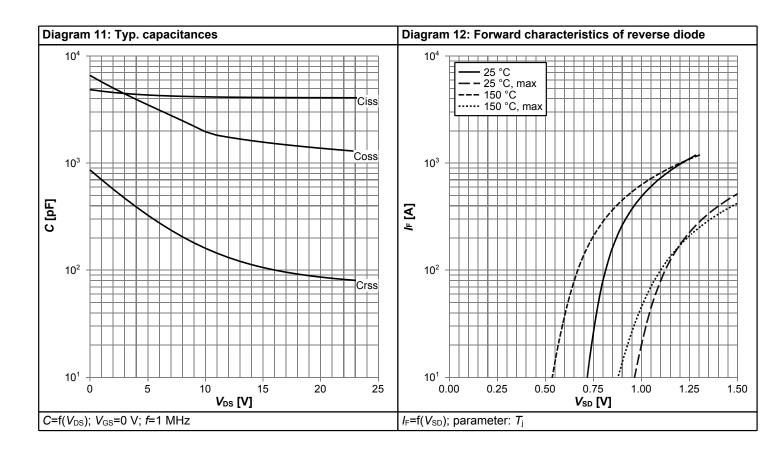




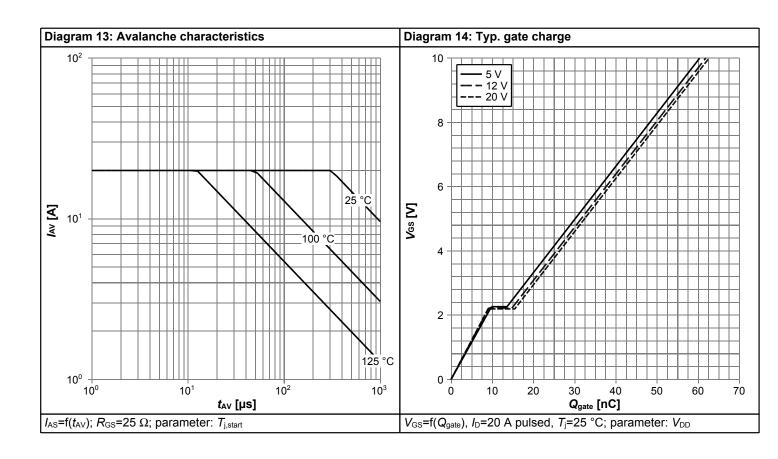


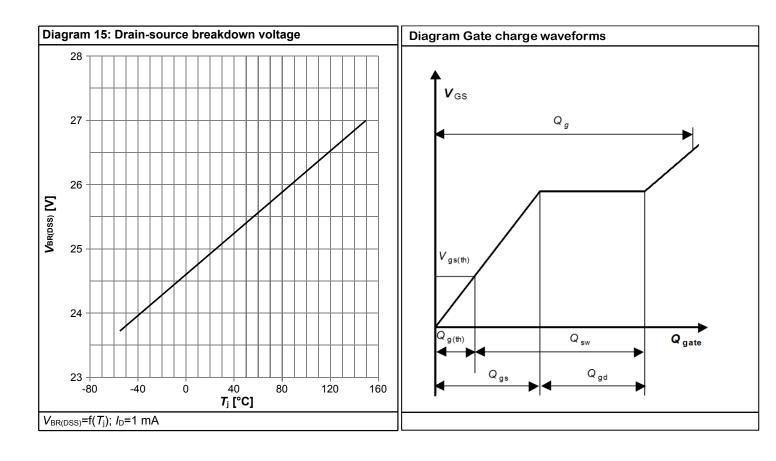






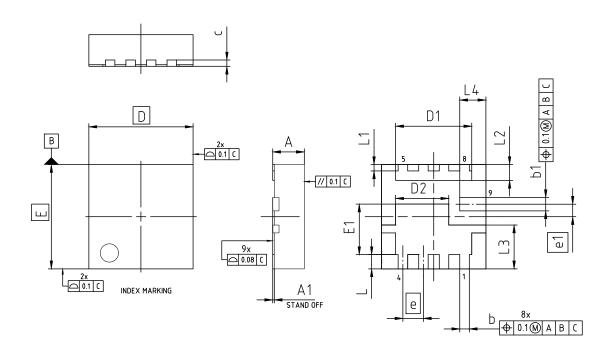








# 5 Package Outlines



DIMENSION	MILLIM	IETERS				
DIMENSION	MIN.	MAX.				
Α	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.	20				
D	3.30					
D1	2.31	2.51				
D2	1.58	1.78				
E	3.	30				
E1	1.50	1.70				
е	0.65					
e1	0.395					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				

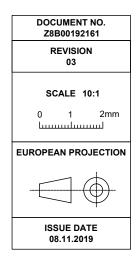


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



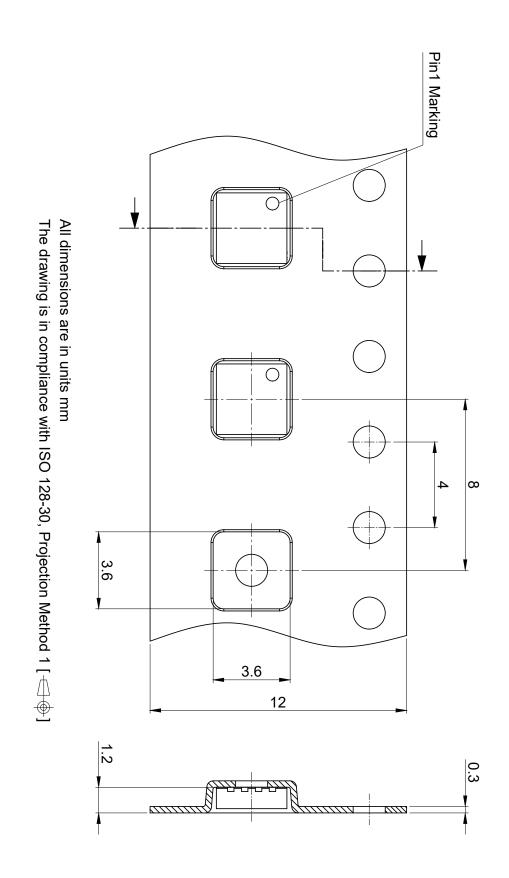


Figure 2 Outline Tape (PG-TTFN-9-1), dimensions in mm



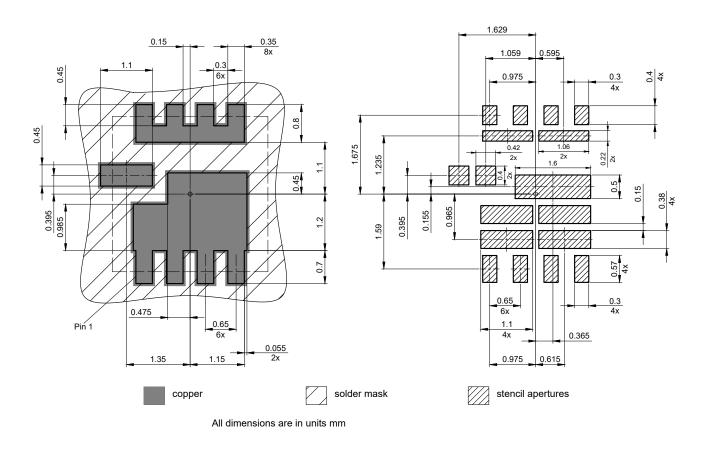


Figure 3 Outline Boardpad (PG-TTFN-9-1), dimensions in mm



## **Revision History**

IQE006NE2LM5CG

Revision: 2020-03-16, Rev. 2.1

Previous Revision

Trovidue Novicien							
Revision	Date	te Subjects (major changes since last revision)					
2.0	2019-12-06	Release of final version					
2.1	2020-03-16	Update footnotes and marking					

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